



Heterojunction Bipolar Transistor Technology (InGaP HBT)

Broadband High Linearity Amplifier

The MMG3014NT1 is a General Purpose Amplifier that is internally input matched and internally output prematched. It is designed for a broad range of Class A, small-signal, high linearity, general purpose applications. It is suitable for applications with frequencies from 40 to 4000 MHz such as cellular, PCS, BWA, WLL, PHS, CATV, VHF, UHF, UMTS and general small-signal RF.

Features

- Frequency: 40-4000 MHz
- P1dB: 25 dBm @ 900 MHz
- Small-Signal Gain: 19.5 dB @ 900 MHz
- Third Order Output Intercept Point: 40.5 dBm @ 900 MHz
- Single 5 Volt Supply
- Active Bias
- Cost-effective SOT-89 Surface Mount Package
- RoHS Compliant
- In Tape and Reel. T1 Suffix = 1,000 Units, 12 mm Tape Width, 7 inch Reel.

MMG3014NT1

**40-4000 MHz, 19.5 dB
25 dBm
InGaP HBT**



**CASE 2142-01
SOT-89
PLASTIC**

Table 1. Typical Performance⁽¹⁾

| Characteristic | Symbol | 900 MHz | 2140 MHz | 3500 MHz | Unit |
|------------------------------------|----------------|---------|----------|----------|------|
| Small-Signal Gain (S21) | G _p | 19.5 | 15 | 10 | dB |
| Input Return Loss (S11) | IRL | -25 | -12 | -8 | dB |
| Output Return Loss (S22) | ORL | -11 | -13 | -19 | dB |
| Power Output @1dB Compression | P1dB | 25 | 25.8 | 25 | dBm |
| Third Order Output Intercept Point | OIP3 | 40.5 | 40.5 | 40 | dBm |

1. V_{CC} = 5 Vdc, T_A = 25°C, 50 ohm system, application circuit tuned for specified frequency.

Table 2. Maximum Ratings

| Rating | Symbol | Value | Unit |
|---------------------------|------------------|-------------|------|
| Supply Voltage | V _{CC} | 6 | V |
| Supply Current | I _{CC} | 300 | mA |
| RF Input Power | P _{in} | 25 | dBm |
| Storage Temperature Range | T _{stg} | -65 to +150 | °C |
| Junction Temperature (2) | T _J | 150 | °C |

2. For reliable operation, the junction temperature should not exceed 150°C.

Table 3. Thermal Characteristics

| Characteristic | Symbol | Value ⁽³⁾ | Unit |
|---|------------------|----------------------|------|
| Thermal Resistance, Junction to Case Case Temperature 81°C, 5 Vdc, 135 mA, no RF applied | R _{θJC} | 27.4 | °C/W |

3. Refer to AN1955, *Thermal Measurement Methodology of RF Power Amplifiers*. Go to <http://www.freescale.com/rf>. Select Documentation/Application Notes - AN1955.

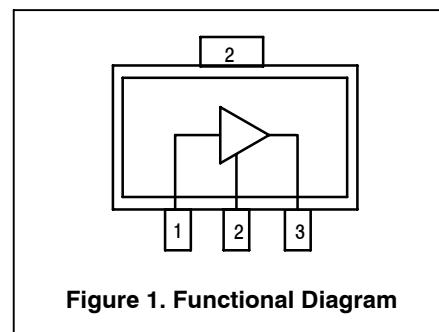
Table 4. Electrical Characteristics ($V_{CC} = 5$ Vdc, 900 MHz, $T_A = 25^\circ\text{C}$, 50 ohm system, in Freescale Application Circuit)

| Characteristic | Symbol | Min | Typ | Max | Unit |
|------------------------------------|----------|------|------|-----|------|
| Small-Signal Gain (S21) | G_p | 18.5 | 19.5 | — | dB |
| Input Return Loss (S11) | IRL | — | -25 | — | dB |
| Output Return Loss (S22) | ORL | — | -11 | — | dB |
| Power Output @ 1dB Compression | P1dB | — | 25 | — | dBm |
| Third Order Output Intercept Point | OIP3 | — | 40.5 | — | dBm |
| Noise Figure | NF | — | 5.7 | — | dB |
| Supply Current (1) | I_{CC} | 110 | 135 | 160 | mA |
| Supply Voltage (1) | V_{CC} | — | 5 | — | V |

1. For reliable operation, the junction temperature should not exceed 150°C.

Table 5. Functional Pin Description

| Pin Number | Pin Function |
|------------|----------------------|
| 1 | RF_{in} |
| 2 | Ground |
| 3 | RF_{out}/DC Supply |

**Figure 1. Functional Diagram****Table 6. ESD Protection Characteristics**

| Test Conditions/Test Methodology | Class |
|---------------------------------------|-------|
| Human Body Model (per JESD22-A114) | 1B |
| Machine Model (per EIA/JESD22-A115) | A |
| Charge Device Model (per JESD22-C101) | IV |

Table 7. Moisture Sensitivity Level

| Test Methodology | Rating | Package Peak Temperature | Unit |
|--------------------------------------|--------|--------------------------|------|
| Per JESD22-A113, IPC/JEDEC J-STD-020 | 1 | 260 | °C |

50 OHM TYPICAL CHARACTERISTICS

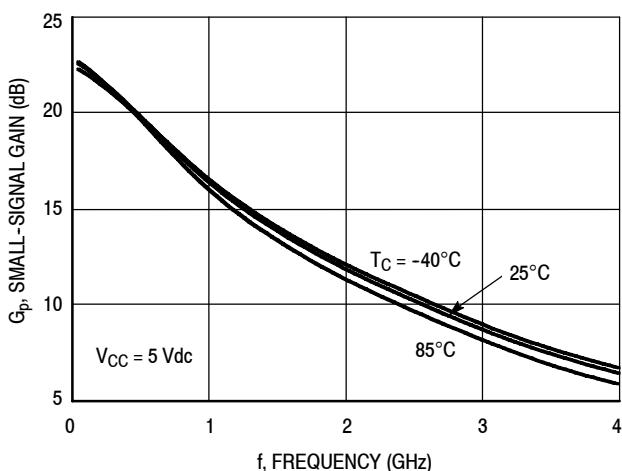


Figure 2. Small-Signal Gain (S21) versus Frequency

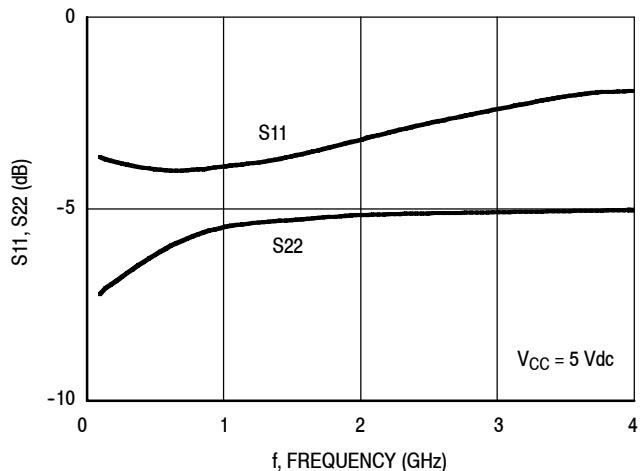


Figure 3. Input/Output Return Loss versus Frequency

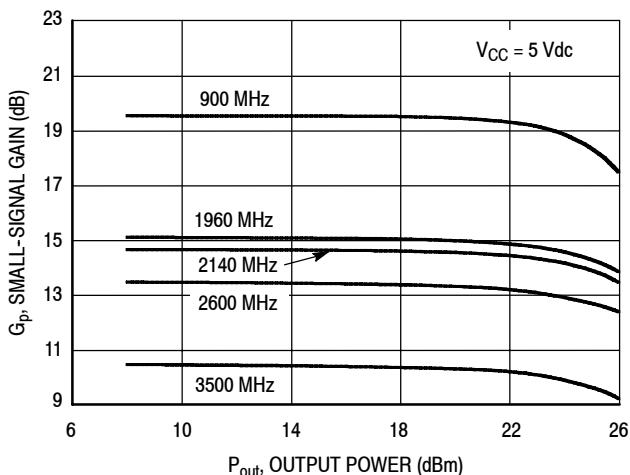


Figure 4. Small-Signal Gain versus Output Power

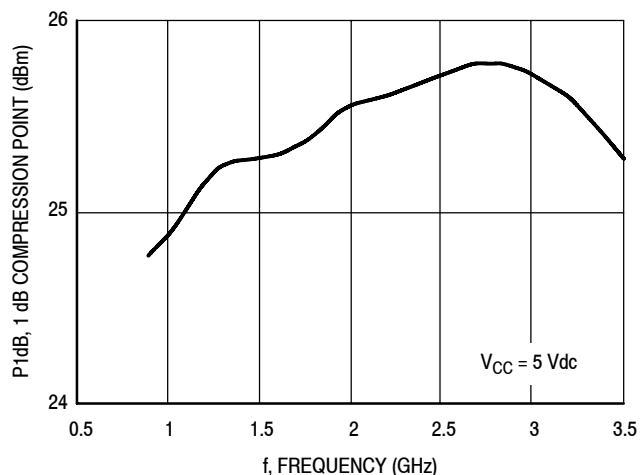


Figure 5. P1dB versus Frequency

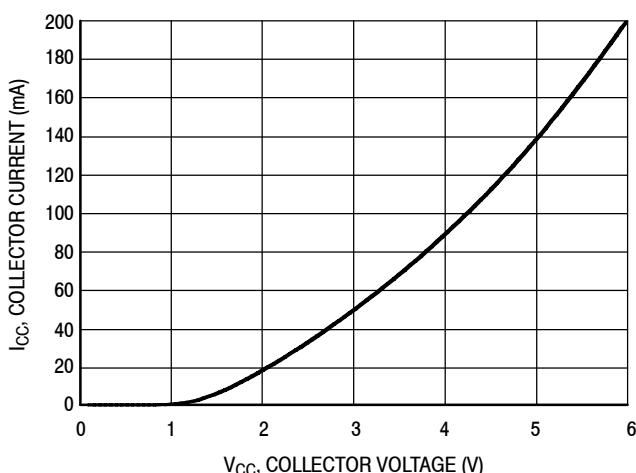


Figure 6. Collector Current versus Collector Voltage

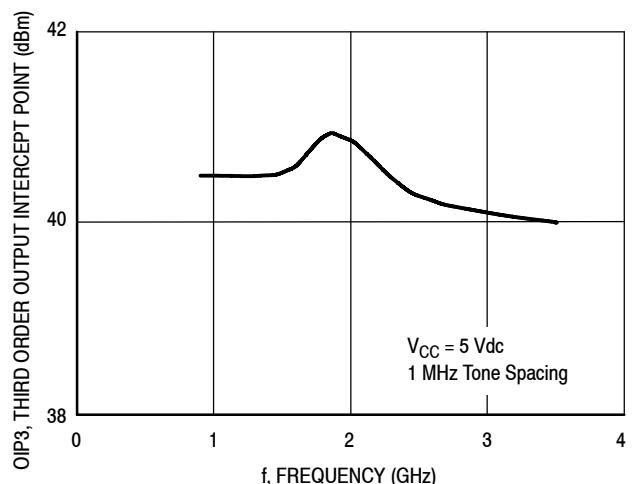


Figure 7. Third Order Output Intercept Point versus Frequency

50 OHM TYPICAL CHARACTERISTICS

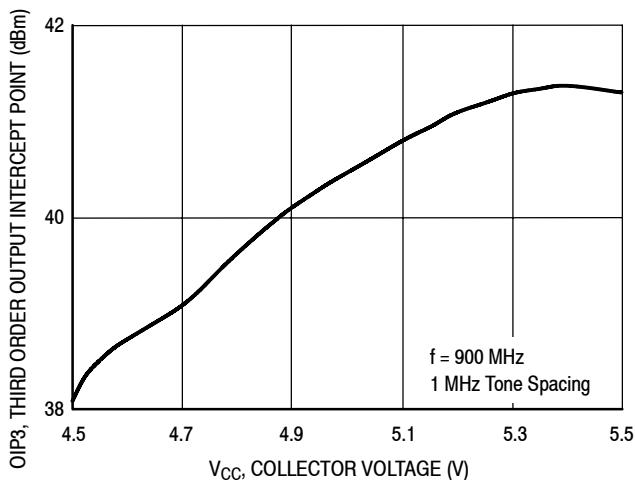


Figure 8. Third Order Output Intercept Point versus Collector Voltage

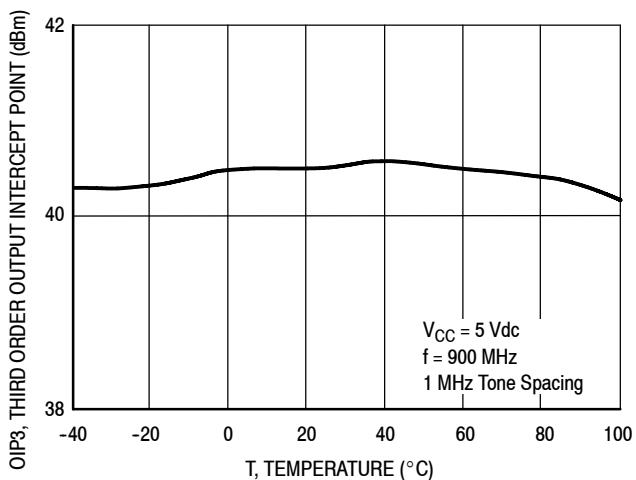


Figure 9. Third Order Output Intercept Point versus Case Temperature

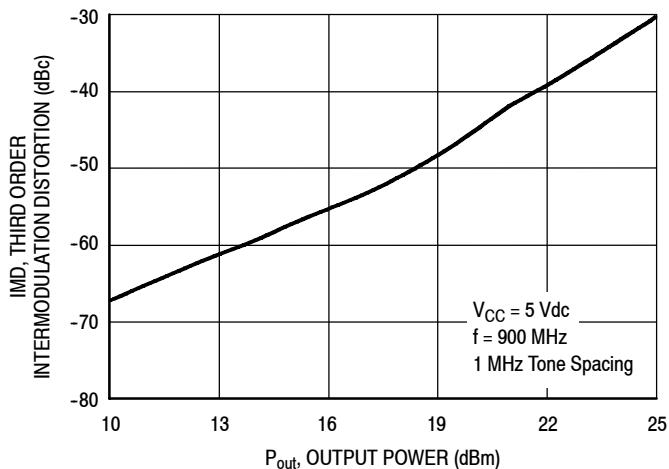
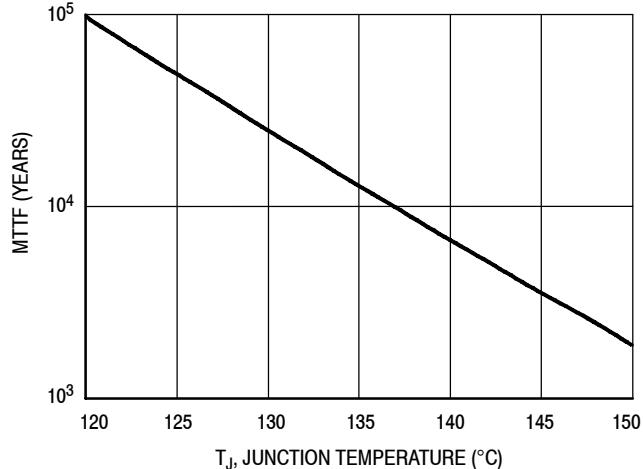


Figure 10. Third Order Intermodulation versus Output Power



NOTE: The MTTF is calculated with $V_{CC} = 5 \text{ Vdc}$, $I_{CC} = 135 \text{ mA}$

Figure 11. MTTF versus Junction Temperature

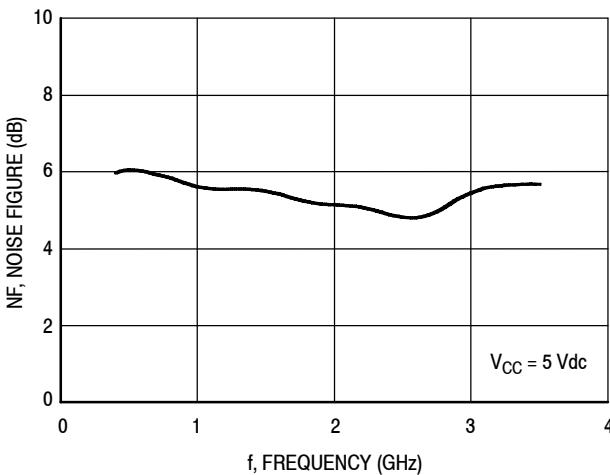


Figure 12. Noise Figure versus Frequency

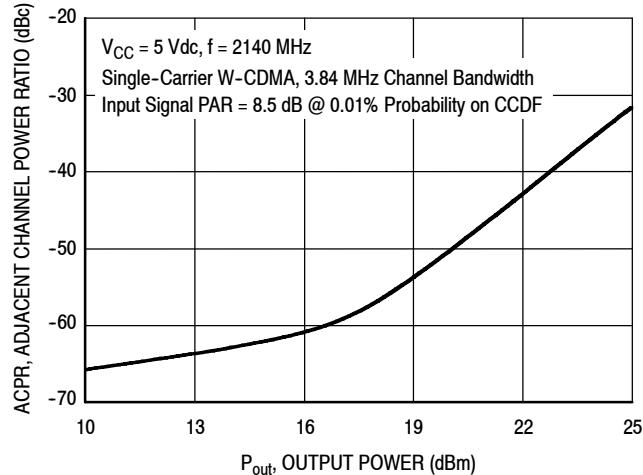


Figure 13. Single-Carrier W-CDMA Adjacent Channel Power Ratio versus Output Power

50 OHM APPLICATION CIRCUIT: 800-1000 MHz

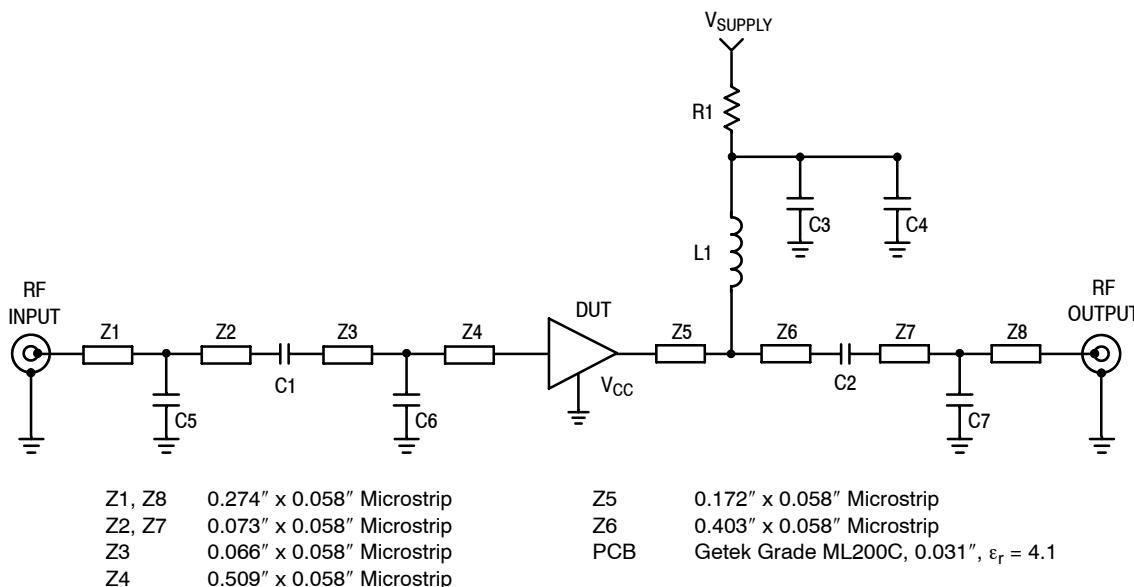


Figure 14. 50 Ohm Test Circuit Schematic

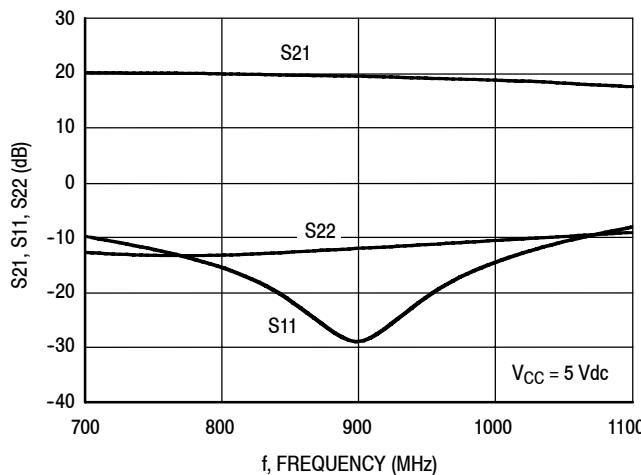


Figure 15. S21, S11 and S22 versus Frequency

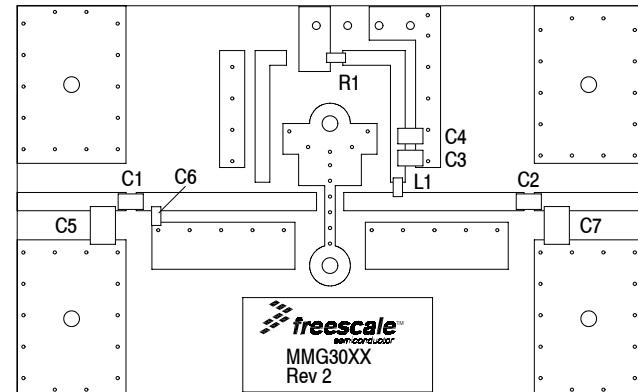


Figure 16. 50 Ohm Test Circuit Component Layout

Table 8. 50 Ohm Test Circuit Component Designations and Values

| Part | Description | Part Number | Manufacturer |
|--------|----------------------------|----------------|--------------|
| C1, C2 | 220 pF Chip Capacitors | C0805C221J5GAC | Kemet |
| C3 | 0.1 μ F Chip Capacitor | C0603C104J5RAC | Kemet |
| C4 | 2.2 μ F Chip Capacitor | C0805C225J4RAC | Kemet |
| C5 | 0.2 pF Chip Capacitor | 12065J0R2BS | AVX |
| C6 | 4.7 pF Chip Capacitor | C0603C479J5GAC | Kemet |
| C7 | 1.8 pF Chip Capacitor | C1206C189D5GAC | Kemet |
| L1 | 10 nH Chip Inductor | HK160810NJ-T | Taiyo Yuden |
| R1 | 0 Ω Chip Resistor | ERJ3GEY0R00V | Panasonic |

50 OHM APPLICATION CIRCUIT: 1800-2200 MHz

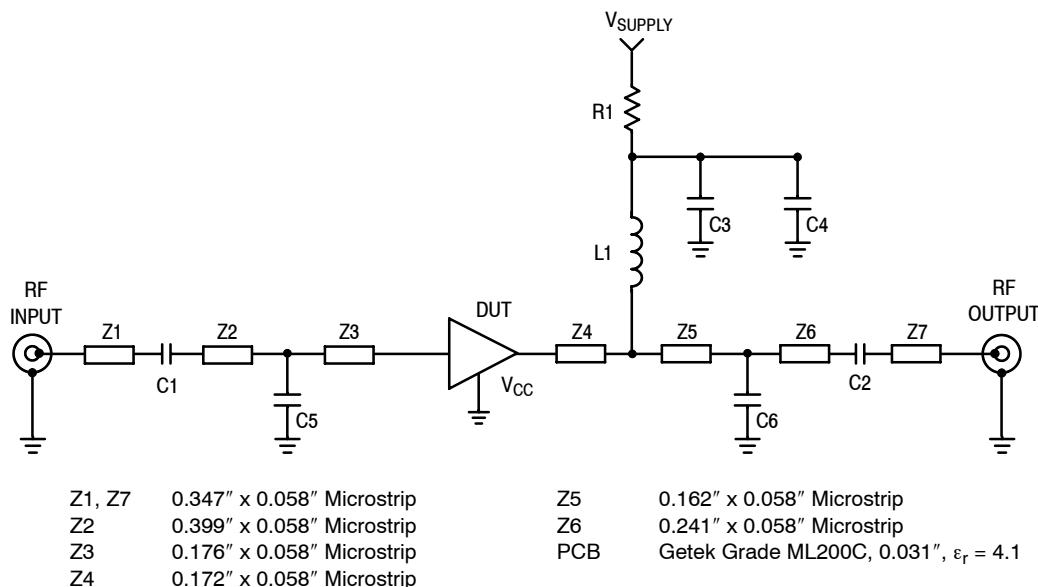


Figure 17. 50 Ohm Test Circuit Schematic

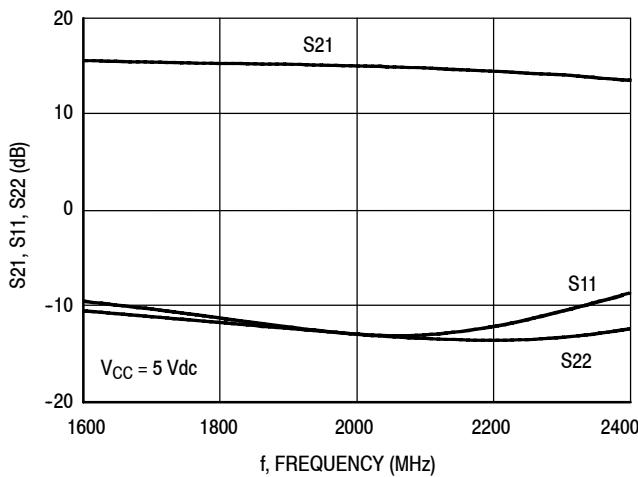


Figure 18. S21, S11 and S22 versus Frequency

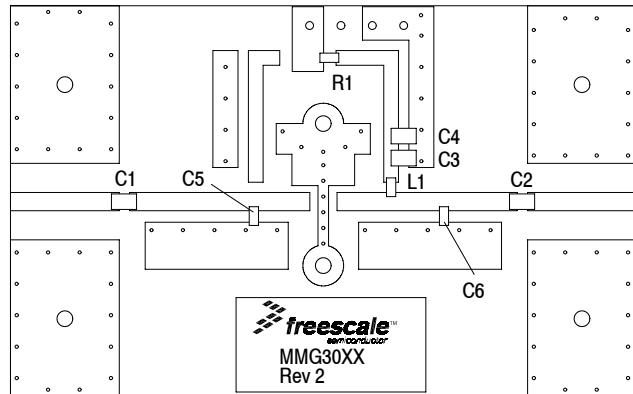


Figure 19. 50 Ohm Test Circuit Component Layout

Table 9. 50 Ohm Test Circuit Component Designations and Values

| Part | Description | Part Number | Manufacturer |
|--------|----------------------------|----------------|--------------|
| C1, C2 | 22 pF Chip Capacitors | C0805C220J5GAC | Kemet |
| C3 | 0.1 μ F Chip Capacitor | C0603C104J5RAC | Kemet |
| C4 | 2.2 μ F Chip Capacitor | C0805C225J4RAC | Kemet |
| C5 | 1.5 pF Chip Capacitor | C0603C159J5RAC | Kemet |
| C6 | 1.1 pF Chip Capacitor | C0603C119J5GAC | Kemet |
| L1 | 15 nH Chip Inductor | HK160815NJ-T | Taiyo Yuden |
| R1 | 0 Ω Chip Resistor | ERJ3GEY0R00V | Panasonic |

50 OHM APPLICATION CIRCUIT: 2300-2700 MHz

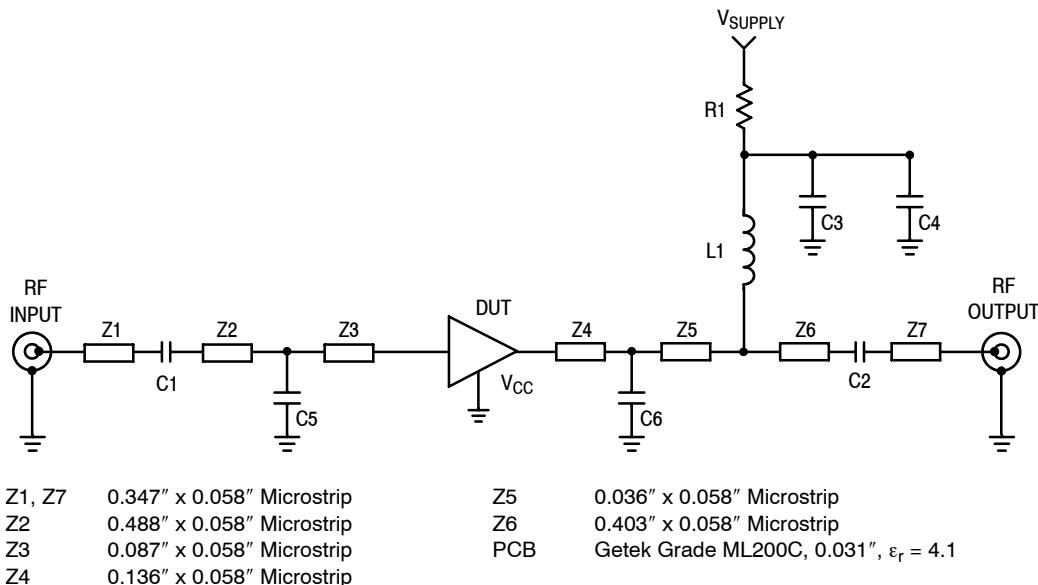


Figure 20. 50 Ohm Test Circuit Schematic

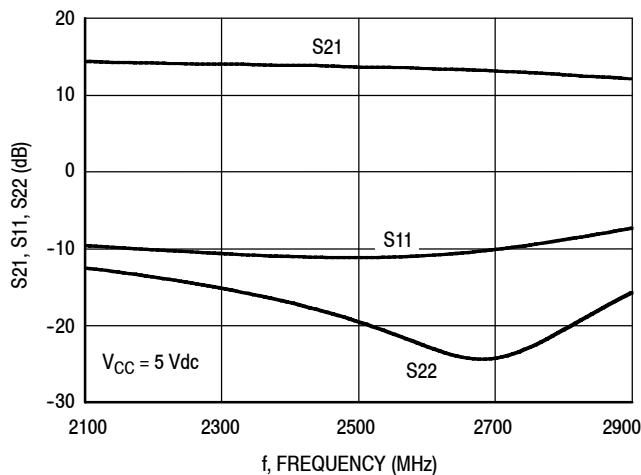


Figure 21. S21, S11 and S22 versus Frequency

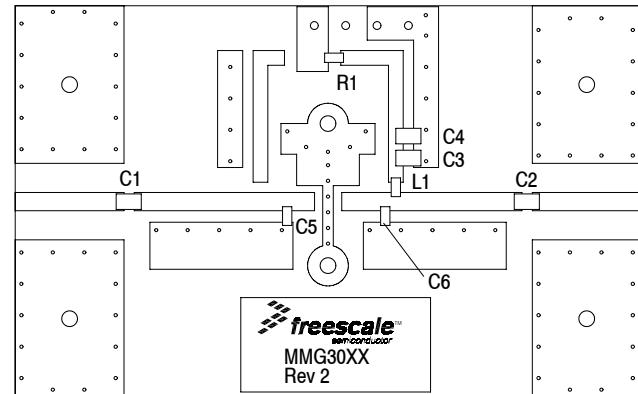


Figure 22. 50 Ohm Test Circuit Component Layout

Table 10. 50 Ohm Test Circuit Component Designations and Values

| Part | Description | Part Number | Manufacturer |
|--------|----------------------------|----------------|--------------|
| C1, C2 | 22 pF Chip Capacitors | C0805C220J5GAC | Kemet |
| C3 | 0.1 μ F Chip Capacitor | C0603C104J5RAC | Kemet |
| C4 | 2.2 μ F Chip Capacitor | C0805C225J4RAC | Kemet |
| C5, C6 | 1.1 pF Chip Capacitors | C0603C119J5GAC | Kemet |
| L1 | 15 nH Chip Inductor | HK160815NJ-T | Taiyo Yuden |
| R1 | 0 Ω Chip Resistor | ERJ3GEY0R00V | Panasonic |

50 OHM APPLICATION CIRCUIT: 3400-3600 MHz

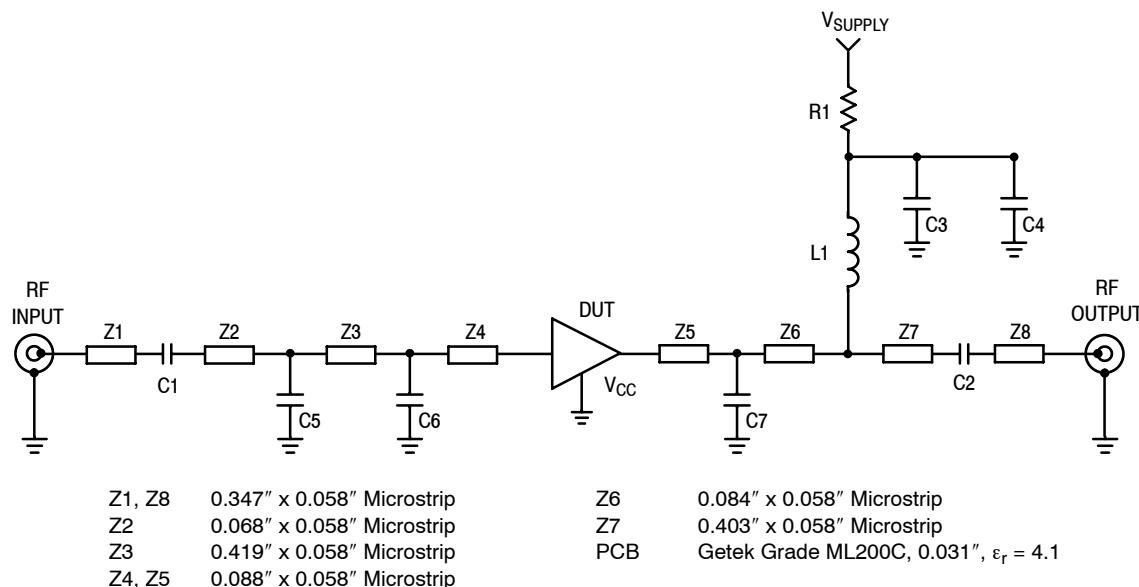


Figure 23. 50 Ohm Test Circuit Schematic

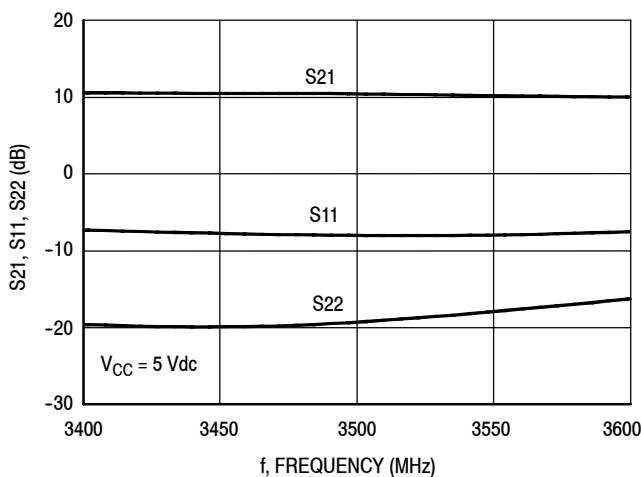


Figure 24. S21, S11 and S22 versus Frequency

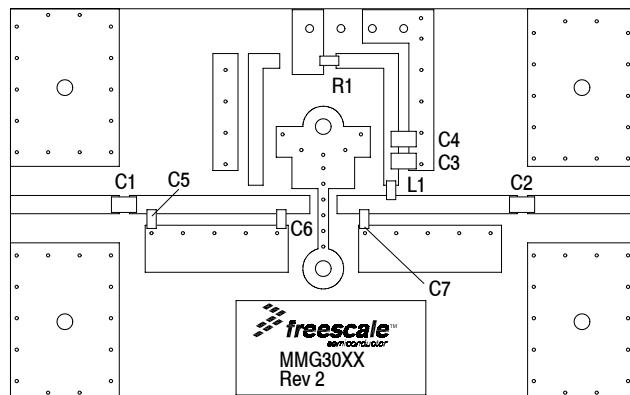


Figure 25. 50 Ohm Test Circuit Component Layout

Table 11. 50 Ohm Test Circuit Component Designations and Values

| Part | Description | Part Number | Manufacturer |
|------|----------------------------|----------------|--------------|
| C1 | 3.3 pF Chip Capacitor | C0805C339J5GAC | Kemet |
| C2 | 2.0 pF Chip Capacitor | C0805C209J5GAC | Kemet |
| C3 | 0.1 μ F Chip Capacitor | C0603C104J5RAC | Kemet |
| C4 | 2.2 μ F Chip Capacitor | C0805C225J4RAC | Kemet |
| C5 | 0.6 pF Chip Capacitor | 06035J0R6BS | AVX |
| C6 | 0.9 pF Chip Capacitor | 06035J0R9BS | AVX |
| C7 | 0.8 pF Chip Capacitor | 06035J0R8BS | AVX |
| L1 | 56 nH Chip Inductor | HK160856NJ-T | Taiyo Yuden |
| R1 | 0 Ω Chip Resistor | ERJ3GEY0R00V | Panasonic |

50 OHM TYPICAL CHARACTERISTICS

Table 12. Common Emitter S-Parameters ($V_{CC} = 5$ Vdc, $T_A = 25^\circ\text{C}$, 50 Ohm System)

| f MHz | S₁₁ | | S₂₁ | | S₁₂ | | S₂₂ | |
|----------|-----------------------|---------------|-----------------------|---------------|-----------------------|---------------|-----------------------|---------------|
| | S ₁₁ | $\angle \phi$ | S ₂₁ | $\angle \phi$ | S ₁₂ | $\angle \phi$ | S ₂₂ | $\angle \phi$ |
| 250 | 0.622 | 174.6 | 10.280 | 153.8 | 0.0336 | 0.6 | 0.448 | -171.6 |
| 300 | 0.618 | 174.0 | 10.107 | 148.3 | 0.0336 | 0.3 | 0.457 | -171.9 |
| 350 | 0.616 | 173.4 | 9.933 | 143.1 | 0.0337 | -0.1 | 0.465 | -172.5 |
| 400 | 0.613 | 173.0 | 9.760 | 138.3 | 0.0337 | -0.4 | 0.475 | -173.3 |
| 450 | 0.611 | 172.5 | 9.586 | 133.8 | 0.0338 | -0.6 | 0.483 | -174.0 |
| 500 | 0.611 | 172.0 | 9.300 | 129.8 | 0.0338 | -0.8 | 0.490 | -174.9 |
| 550 | 0.610 | 171.4 | 9.009 | 126.0 | 0.0339 | -1.0 | 0.497 | -175.8 |
| 600 | 0.610 | 170.9 | 8.716 | 122.4 | 0.0339 | -1.2 | 0.503 | -176.8 |
| 650 | 0.610 | 170.4 | 8.363 | 119.2 | 0.0340 | -1.4 | 0.508 | -177.9 |
| 700 | 0.611 | 169.9 | 8.064 | 116.2 | 0.0340 | -1.6 | 0.512 | -178.9 |
| 750 | 0.615 | 169.5 | 7.734 | 113.3 | 0.0341 | -1.7 | 0.517 | 176.5 |
| 800 | 0.618 | 171.8 | 7.403 | 110.9 | 0.0342 | -1.8 | 0.526 | 175.5 |
| 850 | 0.621 | 171.4 | 7.073 | 108.4 | 0.0342 | -1.9 | 0.533 | 174.5 |
| 900 | 0.625 | 170.9 | 6.838 | 106.0 | 0.0343 | -2.0 | 0.536 | 173.5 |
| 950 | 0.624 | 170.2 | 6.629 | 103.7 | 0.0343 | -2.2 | 0.536 | 172.6 |
| 1000 | 0.624 | 169.6 | 6.422 | 101.5 | 0.0344 | -2.3 | 0.537 | 171.8 |
| 1050 | 0.624 | 168.9 | 6.227 | 99.4 | 0.0344 | -2.5 | 0.537 | 170.9 |
| 1100 | 0.625 | 168.3 | 6.044 | 97.3 | 0.0346 | -2.7 | 0.538 | 169.9 |
| 1150 | 0.626 | 167.6 | 5.866 | 95.4 | 0.0347 | -2.8 | 0.538 | 169.1 |
| 1200 | 0.628 | 166.9 | 5.700 | 93.5 | 0.0349 | -3.0 | 0.539 | 168.2 |
| 1250 | 0.629 | 166.1 | 5.545 | 91.7 | 0.0351 | -3.2 | 0.540 | 167.3 |
| 1300 | 0.632 | 165.4 | 5.393 | 89.9 | 0.0352 | -3.4 | 0.540 | 166.5 |
| 1350 | 0.634 | 164.6 | 5.257 | 88.2 | 0.0354 | -3.6 | 0.541 | 165.6 |
| 1400 | 0.636 | 163.8 | 5.117 | 86.5 | 0.0355 | -3.8 | 0.543 | 164.9 |
| 1450 | 0.640 | 163.0 | 4.988 | 84.8 | 0.0356 | -4.0 | 0.544 | 164.1 |
| 1500 | 0.643 | 162.2 | 4.864 | 83.2 | 0.0357 | -4.2 | 0.545 | 163.3 |
| 1550 | 0.646 | 161.3 | 4.742 | 81.7 | 0.0359 | -4.4 | 0.547 | 162.6 |
| 1600 | 0.649 | 160.5 | 4.630 | 80.1 | 0.0360 | -4.5 | 0.549 | 161.8 |
| 1650 | 0.653 | 159.7 | 4.517 | 78.6 | 0.0361 | -4.8 | 0.550 | 161.1 |
| 1700 | 0.657 | 158.9 | 4.414 | 77.1 | 0.0362 | -5.0 | 0.552 | 160.3 |
| 1750 | 0.661 | 158.0 | 4.312 | 75.6 | 0.0363 | -5.2 | 0.554 | 159.6 |
| 1800 | 0.665 | 157.2 | 4.215 | 74.2 | 0.0364 | -5.5 | 0.556 | 158.9 |
| 1850 | 0.669 | 156.4 | 4.123 | 72.7 | 0.0364 | -5.7 | 0.557 | 158.2 |
| 1900 | 0.673 | 155.5 | 4.033 | 71.3 | 0.0365 | -6.0 | 0.559 | 157.4 |
| 1950 | 0.677 | 154.7 | 3.947 | 69.8 | 0.0366 | -6.3 | 0.560 | 156.7 |
| 2000 | 0.681 | 153.8 | 3.864 | 68.4 | 0.0367 | -6.6 | 0.562 | 156.0 |
| 2050 | 0.685 | 153.0 | 3.783 | 67.0 | 0.0367 | -6.9 | 0.563 | 155.2 |
| 2100 | 0.689 | 152.2 | 3.707 | 65.5 | 0.0368 | -7.2 | 0.564 | 154.4 |
| 2150 | 0.693 | 151.3 | 3.633 | 64.1 | 0.0369 | -7.6 | 0.564 | 153.6 |
| 2200 | 0.697 | 150.5 | 3.562 | 62.7 | 0.0369 | -7.9 | 0.565 | 152.8 |
| 2250 | 0.701 | 149.6 | 3.494 | 61.3 | 0.0370 | -8.3 | 0.565 | 152.0 |
| 2300 | 0.705 | 148.7 | 3.426 | 59.8 | 0.0371 | -8.7 | 0.565 | 151.2 |
| 2350 | 0.709 | 147.8 | 3.363 | 58.4 | 0.0371 | -9.1 | 0.564 | 150.3 |

(continued)

MMG3014NT1

50 OHM TYPICAL CHARACTERISTICS

Table 12. Common Emitter S-Parameters ($V_{CC} = 5$ Vdc, $T_A = 25^\circ\text{C}$, 50 Ohm System) (continued)

| f MHz | S₁₁ | | S₂₁ | | S₁₂ | | S₂₂ | |
|----------|-----------------------|-------|-----------------------|------|-----------------------|-------|-----------------------|-------|
| | S ₁₁ | ∠ φ | S ₂₁ | ∠ φ | S ₁₂ | ∠ φ | S ₂₂ | ∠ φ |
| 2400 | 0.712 | 146.9 | 3.299 | 57.0 | 0.0372 | -9.5 | 0.564 | 149.5 |
| 2450 | 0.715 | 146.0 | 3.240 | 55.6 | 0.0373 | -9.9 | 0.563 | 148.6 |
| 2500 | 0.719 | 145.0 | 3.181 | 54.1 | 0.0373 | -10.3 | 0.562 | 147.7 |
| 2550 | 0.722 | 144.1 | 3.124 | 52.7 | 0.0374 | -10.8 | 0.562 | 146.8 |
| 2600 | 0.724 | 143.1 | 3.071 | 51.3 | 0.0374 | -11.2 | 0.561 | 145.9 |
| 2650 | 0.728 | 142.2 | 3.017 | 49.9 | 0.0375 | -11.6 | 0.560 | 145.0 |
| 2700 | 0.730 | 141.2 | 2.968 | 48.5 | 0.0376 | -12.0 | 0.559 | 144.0 |
| 2750 | 0.733 | 140.2 | 2.920 | 47.1 | 0.0377 | -12.4 | 0.559 | 143.1 |
| 2800 | 0.736 | 139.2 | 2.872 | 45.8 | 0.0378 | -12.9 | 0.558 | 142.1 |
| 2850 | 0.738 | 138.2 | 2.828 | 44.4 | 0.0380 | -13.4 | 0.557 | 141.1 |
| 2900 | 0.740 | 137.2 | 2.784 | 43.0 | 0.0381 | -13.8 | 0.557 | 140.1 |
| 2950 | 0.742 | 136.2 | 2.743 | 41.7 | 0.0382 | -14.4 | 0.557 | 139.1 |
| 3000 | 0.745 | 135.2 | 2.703 | 40.3 | 0.0384 | -14.9 | 0.557 | 138.1 |
| 3050 | 0.747 | 134.2 | 2.664 | 39.0 | 0.0385 | -15.4 | 0.557 | 137.1 |
| 3100 | 0.749 | 133.1 | 2.627 | 37.6 | 0.0386 | -15.9 | 0.557 | 136.1 |
| 3150 | 0.751 | 132.1 | 2.590 | 36.3 | 0.0388 | -16.4 | 0.557 | 135.1 |
| 3200 | 0.753 | 131.1 | 2.555 | 35.0 | 0.0389 | -17.0 | 0.558 | 134.1 |
| 3250 | 0.756 | 130.1 | 2.521 | 33.7 | 0.0390 | -17.5 | 0.558 | 133.2 |
| 3300 | 0.758 | 129.1 | 2.487 | 32.4 | 0.0391 | -18.0 | 0.559 | 132.2 |
| 3350 | 0.760 | 128.1 | 2.455 | 31.1 | 0.0393 | -18.5 | 0.560 | 131.3 |
| 3400 | 0.762 | 127.1 | 2.422 | 29.8 | 0.0394 | -19.0 | 0.560 | 130.5 |
| 3450 | 0.764 | 126.1 | 2.392 | 28.6 | 0.0395 | -19.5 | 0.561 | 129.6 |
| 3500 | 0.766 | 125.1 | 2.361 | 27.3 | 0.0396 | -20.0 | 0.562 | 128.9 |
| 3550 | 0.768 | 124.2 | 2.331 | 26.1 | 0.0397 | -20.5 | 0.563 | 128.1 |
| 3600 | 0.770 | 123.2 | 2.302 | 24.9 | 0.0398 | -21.0 | 0.564 | 127.4 |
| 3650 | 0.772 | 122.3 | 2.273 | 23.7 | 0.0399 | -21.4 | 0.565 | 126.7 |
| 3700 | 0.774 | 121.3 | 2.246 | 22.6 | 0.0400 | -21.8 | 0.566 | 126.1 |
| 3750 | 0.775 | 120.4 | 2.218 | 21.5 | 0.0401 | -22.2 | 0.567 | 125.6 |
| 3800 | 0.777 | 119.5 | 2.192 | 20.4 | 0.0403 | -22.6 | 0.568 | 125.1 |
| 3850 | 0.778 | 118.6 | 2.167 | 19.2 | 0.0404 | -23.0 | 0.569 | 124.6 |
| 3900 | 0.780 | 117.6 | 2.142 | 18.1 | 0.0405 | -23.4 | 0.570 | 124.2 |
| 3950 | 0.781 | 116.7 | 2.118 | 17.1 | 0.0406 | -23.9 | 0.571 | 123.7 |
| 4000 | 0.783 | 115.8 | 2.091 | 16.0 | 0.0407 | -24.2 | 0.572 | 123.5 |

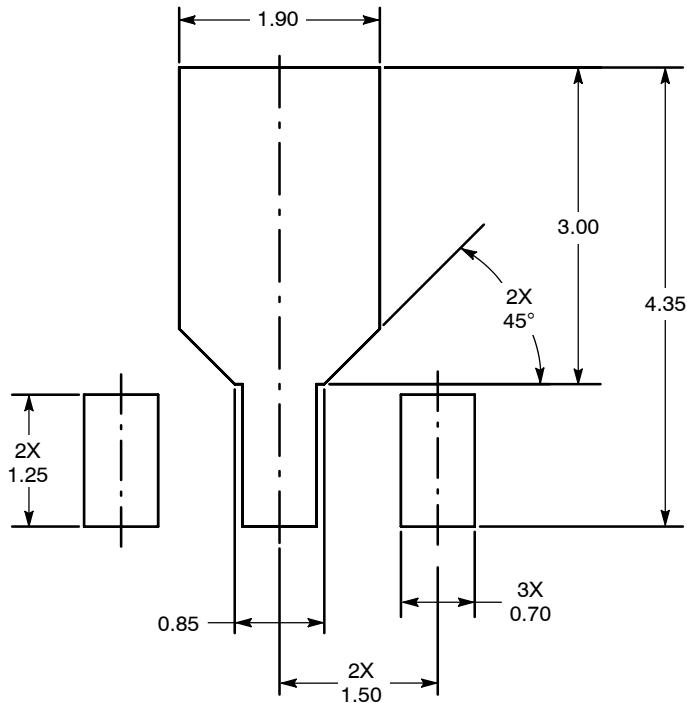
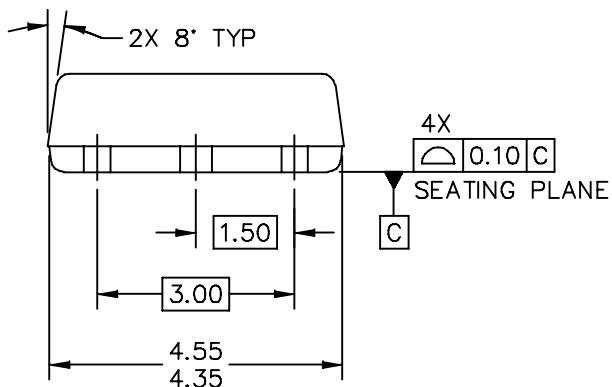
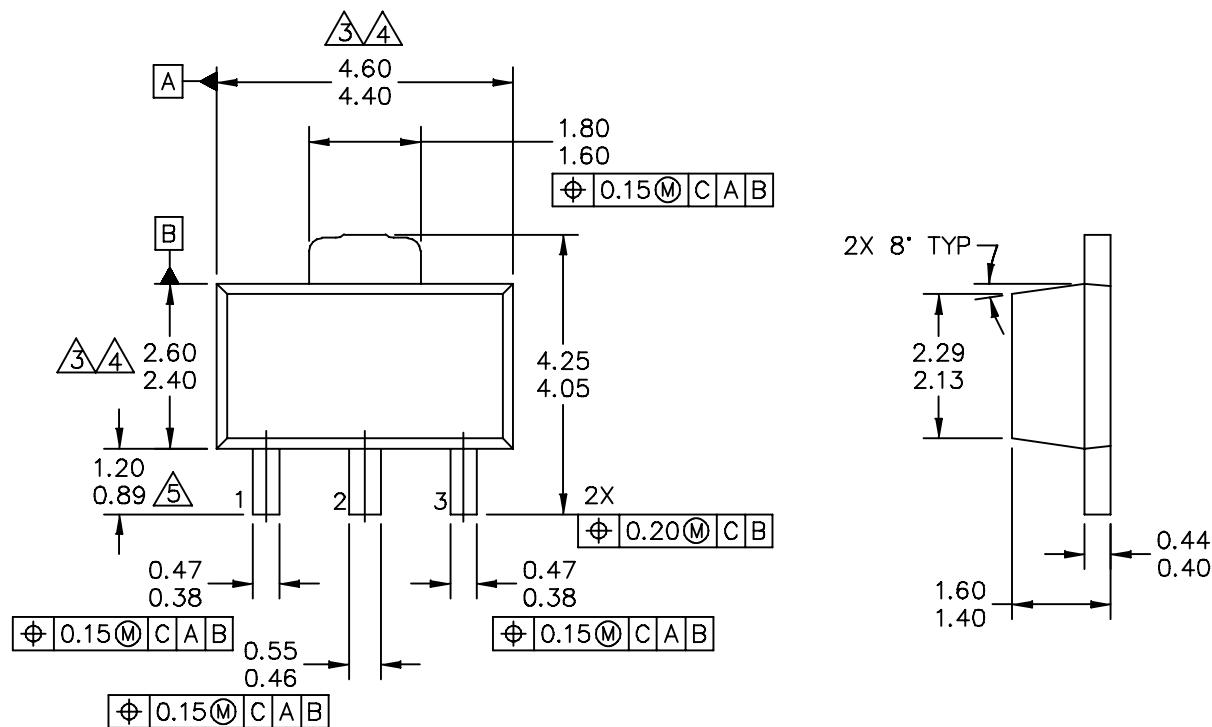


Figure 26. PCB Pad Layout for SOT-89A

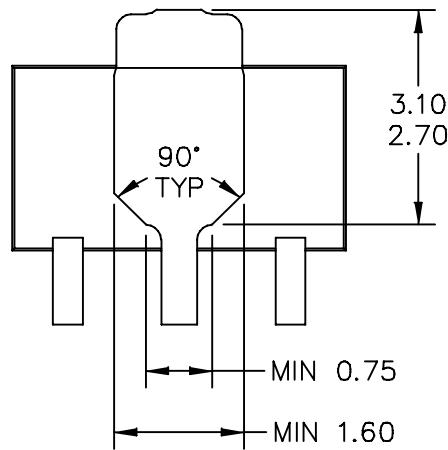


Figure 27. Product Marking

PACKAGE DIMENSIONS



| © FREESCALE SEMICONDUCTOR, INC. ALL RIGHTS RESERVED. | MECHANICAL OUTLINE | PRINT VERSION NOT TO SCALE |
|---|---|----------------------------|
| TITLE: SOT-89A, 3 LEAD, 4.5 X 2.5 PKG, 1.5 MM PITCH | DOCUMENT NO: 98ASA00241D CASE NUMBER: 2142-01 STANDARD: NON-JEDEC | REV: 0 15 JUL 2010 |



BOTTOM VIEW

| | | |
|---|---|----------------------------|
| © FREESCALE SEMICONDUCTOR, INC. ALL RIGHTS RESERVED. | MECHANICAL OUTLINE | PRINT VERSION NOT TO SCALE |
| TITLE: SOT-89A, 3 LEAD, 4.5 X 2.5 PKG, 1.5 MM PITCH | DOCUMENT NO: 98ASA00241D CASE NUMBER: 2142-01 STANDARD: NON-JEDEC | REV: 0 15 JUL 2010 |

MMG3014NT1

NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M – 1994.
2. ALL DIMENSIONS ARE IN MILLIMETERS.
3. DIMENSIONS DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.5 MM PER END. DIMENSION DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.5 MM PER SIDE.
4. DIMENSION ARE DETERMINED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
5. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.

| | | |
|---|---|----------------------------|
| © FREESCALE SEMICONDUCTOR, INC. ALL RIGHTS RESERVED. | MECHANICAL OUTLINE | PRINT VERSION NOT TO SCALE |
| TITLE: SOT-89A, 3 LEAD, 4.5 X 2.5 PKG, 1.5 MM PITCH | DOCUMENT NO: 98ASA00241D CASE NUMBER: 2142-01 STANDARD: NON-JEDEC | REV: 0 15 JUL 2010 |
| | | |

PRODUCT DOCUMENTATION, SOFTWARE AND TOOLS

Refer to the following documents to aid your design process.

Application Notes

- AN1955: Thermal Measurement Methodology of RF Power Amplifiers
- AN3100: General Purpose Amplifier Biasing

Software

- .s2p File

Development Tools

- Printed Circuit Boards

Reference Designs

- 2110-2170 MHz, 4 W, 28 V W-CDMA Smart Demo Reference Design (Devices MMG3014N, MW7IC2240N)

For Software and Tools, do a Part Number search at <http://www.freescale.com>, and select the “Part Number” link. Go to the Software & Tools tab on the part’s Product Summary page to download the respective tool.

REVISION HISTORY

The following table summarizes revisions to this document.

| Revision | Date | Description |
|----------|------------|--|
| 0 | Apr. 2008 | <ul style="list-style-type: none">• Initial Release of Data Sheet |
| 1 | Sept. 2008 | <ul style="list-style-type: none">• Updated Fig. 15, “S21, S11 and S22 versus Frequency”, to correct S11 and S22 curve label transposition error, p. 6• Updated data in Table 12, “Common Emitter S-Parameters”, for better simulation response, p. 10 and 11 |
| 2 | Jan. 2011 | <ul style="list-style-type: none">• Corrected temperature at which ThetaJC is measured from 25°C to 81°C and added “no RF applied” to Thermal Characteristics table to indicate that thermal characterization is performed under DC test with no RF signal applied, p. 1• Removed I_{CC} bias callout from applicable graphs as bias is not a controlled value, p. 4-9• Removed I_{CC} bias callout from Table 12, Common Source S-Parameters heading as bias is not a controlled value, 10-11• Added .s2p file and Printed Circuit Boards availability to Software and Tools, p. 16• Added Reference Design availability to Development Tools, p. 16 |
| 3 | Oct. 2011 | <ul style="list-style-type: none">• Table 1, Maximum Ratings, increased Input Power from 15 dBm to 25 dBm to reflect the true capability of the device, p. 1• Changed ESD Human Body Model rating from Class 1C to Class 1B to reflect recent ESD test results of the device, p. 2• Corrected part number for the C7 capacitor in Table 8, 50 Ohm Test Circuit Component Designations and Values, from C0603C189J5GAC to C1206C189D5GAC p. 5.• Replaced the PCB Pad Layout drawing, the package isometric and mechanical outline for Case 1514-02 (SOT-89) with Case 2142-01 (SOT-89) as a result of the device transfer from a Freescale wafer fab to an external GaAs wafer fab and new assembly site. The new assembly and test site’s SOT-89 package has slight dimensional differences., p. 1, 11-14. Refer to PCN13337, <i>GaAs Fab Transfer</i>. |

How to Reach Us:

Home Page:

www.freescale.com

Web Support:

<http://www.freescale.com/support>

USA/Europe or Locations Not Listed:

Freescale Semiconductor, Inc.
Technical Information Center, EL516
2100 East Elliot Road
Tempe, Arizona 85284
1-800-521-6274 or +1-480-768-2130
www.freescale.com/support

Europe, Middle East, and Africa:

Freescale Halbleiter Deutschland GmbH
Technical Information Center
Schatzbogen 7
81829 Muenchen, Germany
+44 1296 380 456 (English)
+46 8 52200080 (English)
+49 89 92103 559 (German)
+33 1 69 35 48 48 (French)
www.freescale.com/support

Japan:

Freescale Semiconductor Japan Ltd.
Headquarters
ARCO Tower 15F
1-8-1, Shimo-Meguro, Meguro-ku,
Tokyo 153-0064
Japan
0120 191014 or +81 3 5437 9125
support.japan@freescale.com

Asia/Pacific:

Freescale Semiconductor China Ltd.
Exchange Building 23F
No. 118 Jianguo Road
Chaoyang District
Beijing 100022
China
+86 10 5879 8000
support.asia@freescale.com

For Literature Requests Only:

Freescale Semiconductor Literature Distribution Center
1-800-441-2447 or +1-303-675-2140
Fax: +1-303-675-2150
LDCForFreescaleSemiconductor@hibbertgroup.com

Information in this document is provided solely to enable system and software implementers to use Freescale Semiconductor products. There are no express or implied copyright licenses granted hereunder to design or fabricate any integrated circuits or integrated circuits based on the information in this document.

Freescale Semiconductor reserves the right to make changes without further notice to any products herein. Freescale Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does Freescale Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation consequential or incidental damages. "Typical" parameters that may be provided in Freescale Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals", must be validated for each customer application by customer's technical experts. Freescale Semiconductor does not convey any license under its patent rights nor the rights of others. Freescale Semiconductor products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the Freescale Semiconductor product could create a situation where personal injury or death may occur. Should Buyer purchase or use Freescale Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold Freescale Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that Freescale Semiconductor was negligent regarding the design or manufacture of the part.

Freescale™ and the Freescale logo are trademarks of Freescale Semiconductor, Inc. All other product or service names are the property of their respective owners.
© Freescale Semiconductor, Inc. 2008, 2011. All rights reserved.

